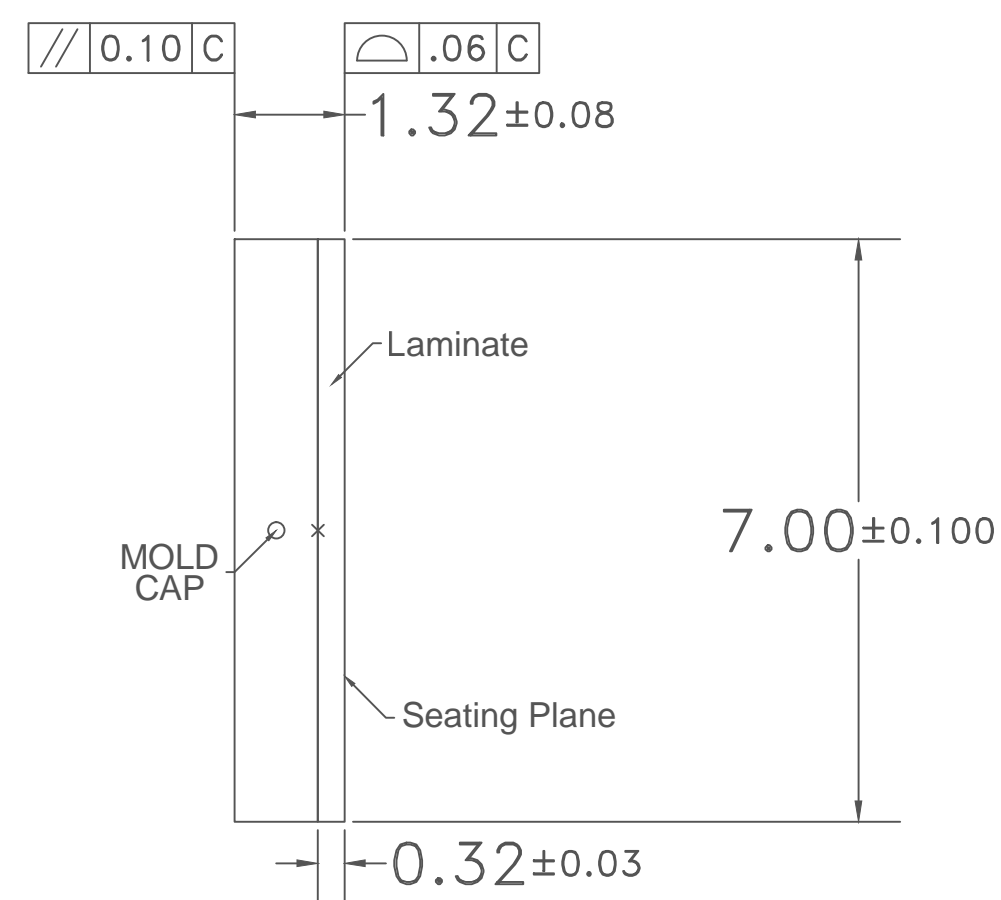


TOP
VIEW



SIDE
VIEW

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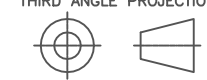
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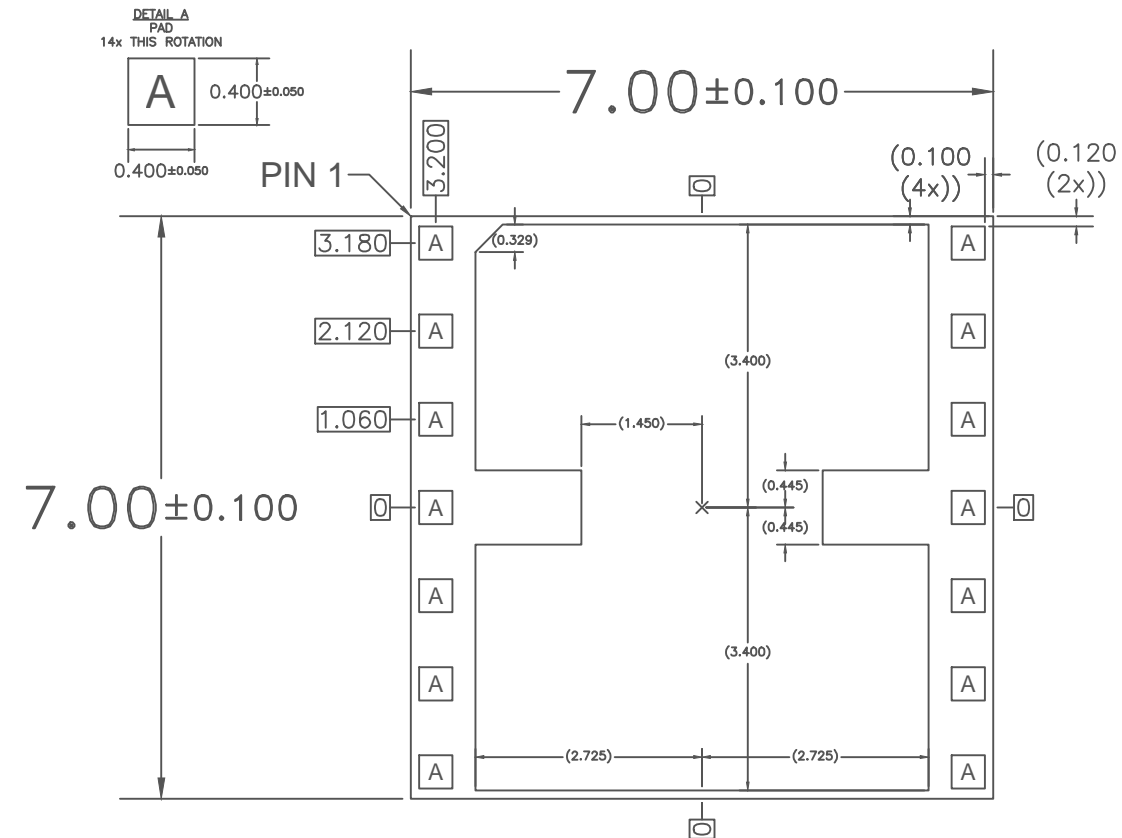
UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN MILLIMETERS

DECIMAL	ANGULAR
X.X ± 0.1	±1°
X.XX ± 0.05	
X.XXX ± 0.025	

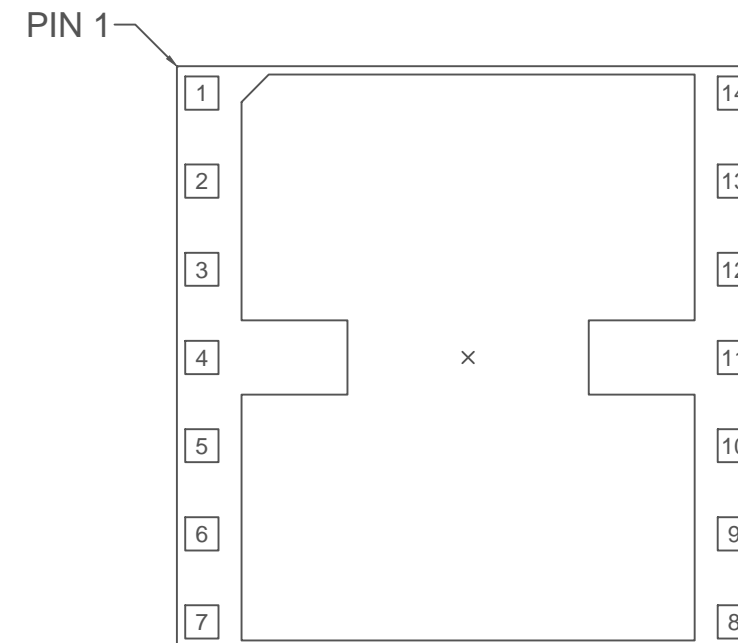
INTERPRET DIM AND TOL PER
ASME Y14.5M - 1994
THIRD ANGLE PROJECTION



DRAWN BY:	R. Stiles				
DRAWN DATE:	01/25/2016				
DOCUMENT TYPE:	PACKAGE OUTLINE DRAWING				
FAMILY GROUP:	QPA9426				
DRAWING NUMBER:	QPA9426			-250	
A3H	SCALE	SHEET NAME		SHEET:	REV
	1:1	TOP		1 of 5	B



TOPxRAY
VIEW



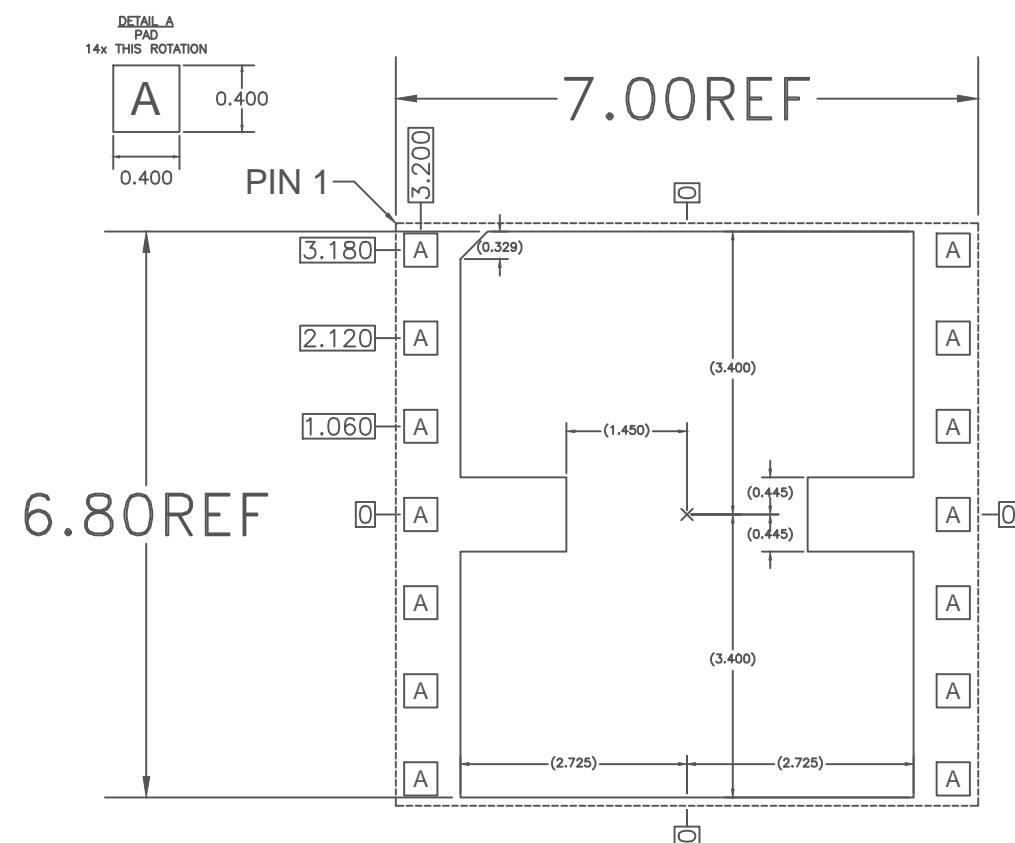
TOPxRAY PINS
VIEW

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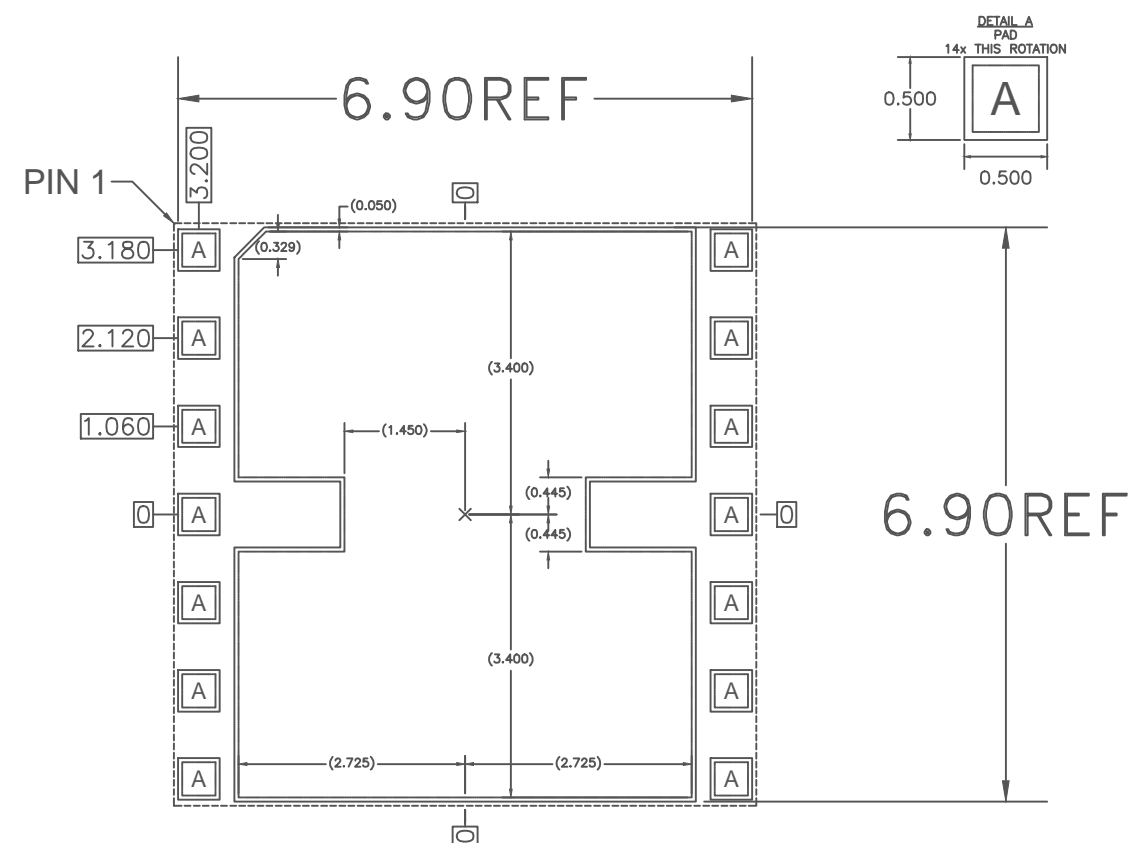
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DRAWING NUMBER:	QPA9426		-250
A3H	SCALE 1:1	SHEET NAME TOPxRAY	SHEET: 2 of 5 REV B



RECOMMENDED
LAND PATTERN



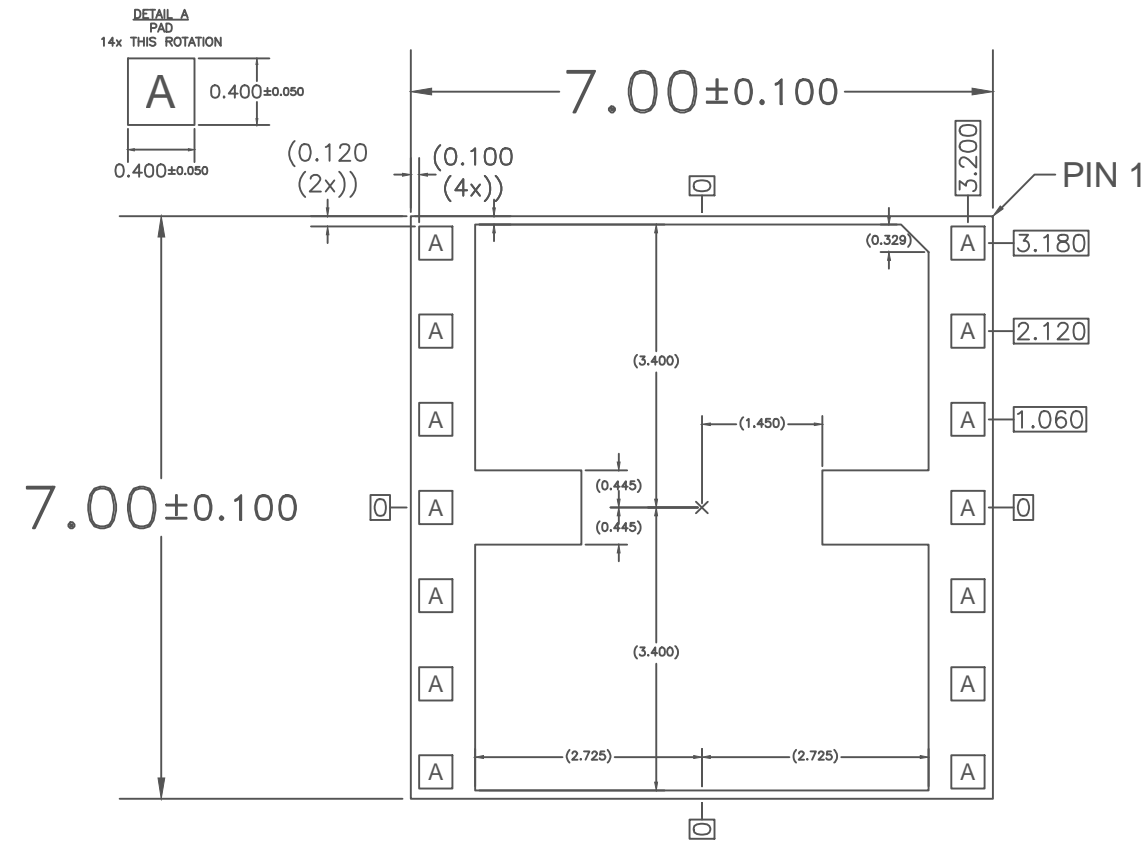
RECOMMENDED
LAND PATTERN MASK

QORVO CONFIDENTIAL

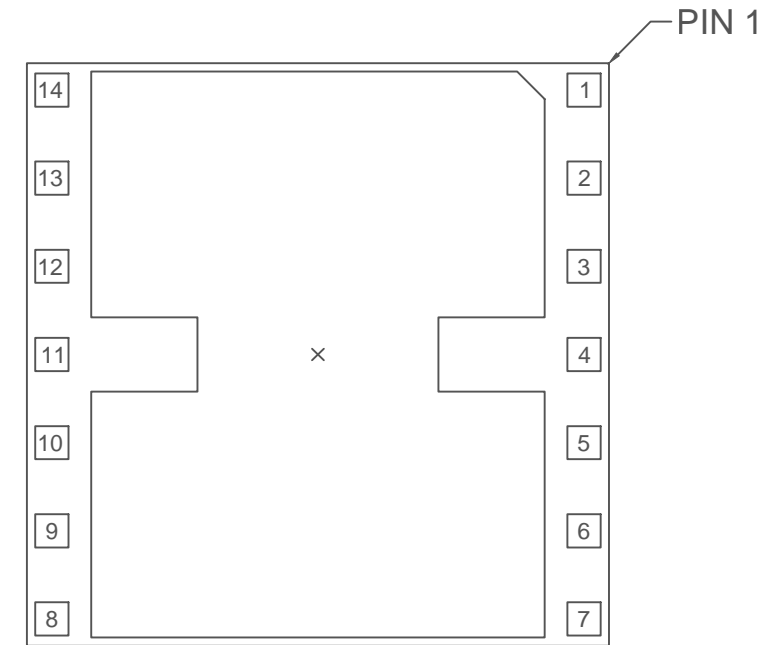
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DRAWING NUMBER:	QPA9426		-250
A3H	SCALE 1:1	SHEET NAME RLP	SHEET: 3 of 5 REV B



BOTTOM
VIEW



BOTTOM PINS
VIEW

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DRAWING NUMBER:	QPA9426		-250
A3H	SCALE 1:1	SHEET NAME BOT	SHEET: 4 of 5 REV B

From (Document Number and Revision)	Description	To (Document Number and Revision)	Date:	By:	
	Initial release based on QPA9226v0101	A	01/25/2016	RS	
	Added the marking substrate tolerance & corrected package thickness tolerance from +/- 0.060 to 0.080mm	B	06/01/2016	M. Nava	

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DRAWING NUMBER:	QPA9426		-250	
A3H	SCALE 1:1	SHEET NAME	SHEET: 5 of 5	REV B